

2.5 V or 3.3 V, 10 MHz–220 MHz, Low Jitter, Nine-Output Zero Delay Buffer

Features

- 10 MHz to 220 MHz maximum operating range
- Zero input-output propagation delay, adjustable by loading on CLKOUT pin
- Multiple low-skew outputs
 - □ 45 ps typical output-output skew
 - □ One input drives nine outputs, grouped as 4 + 4 + 1
- 25 ps typical cycle-to-cycle jitter
- 15 ps typical period jitter
- Standard and High drive strength options
- Available in space-saving 16-pin 150-mil small outline integrated circuit (SOIC) or 4.4 mm thin shrunk small outline package (TSSOP) packages
- 3.3 V or 2.5 V operation
- Industrial temperature available

Functional Description

The CY23EP09 is a 2.5 V or 3.3 V zero delay buffer designed to distribute high-speed clocks and is available in a 16-pin SOIC or TSSOP package. The -1H version operates up to 220 (200) MHz frequencies at 3.3 V (2.5 V), and has higher drive than the -1 devices. All parts have on-chip PLLs that lock to an input clock on the REF pin. The phase-locked loop (PLL) feedback is on-chip and is obtained from the CLKOUT pad.

There are two banks of four outputs each, which can be controlled by the Select inputs as shown in the Select Input Decoding on page 4. If all output clocks are not required, BankB can be three-stated. The select inputs also allow the input clock to be directly applied to the outputs for chip and system testing purposes.

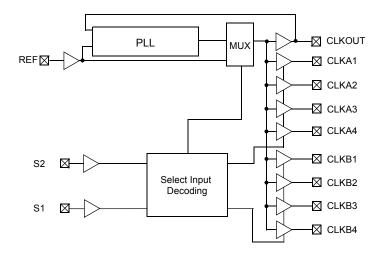
The PLL enters a power-down mode when there are no rising edges on the REF input (less than ~2 MHz). In this state, the outputs are three-stated and the PLL is turned off, resulting in less than 25 μ A of current draw.

In the special case when S2:S1 is 1:0, the PLL is bypassed and REF is output from DC to the maximum allowable frequency. The part behaves like a non-zero delay buffer in this mode, and the outputs are not tri-stated.

The CY23EP09 is available in different configurations, as shown in the Ordering Information table. The CY23EP09-1 is the base part. The CY23EP09-1H is the high-drive version of the -1, and its rise and fall times are much faster than the -1.

These parts are not intended for 5 V input-tolerant applications For a complete list of related documentation, click here.

Block Diagram





Contents

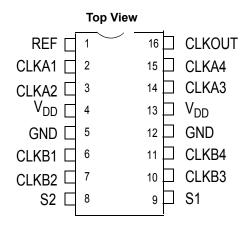
Pin Configuration	3
Pin Definitions	
Select Input Decoding	4
Zero Delay and Skew Control	
Absolute Maximum Conditions	
Operating Conditions	
Electrical Specifications	
Electrical Specifications	
Thermal Resistance	
Test Circuits	
Electrical Specifications	
Switching Waveforms	
Supplemental Parametric Information	

Ordering Information	15
Ordering Code Definitions	15
Package Diagrams	16
Acronyms	17
Document Conventions	17
Units of Measure	17
Document History Page	18
Sales, Solutions, and Legal Information	19
Worldwide Sales and Design Support	19
Products	19
PSoC®Solutions	19
Cypress Developer Community	19
Technical Support	19



Pin Configuration

Figure 1. 16-pin SOIC or TSSOP pinout (Top View)



Pin Definitions

Pin No.	Signal	Description	
1	REF [1]	Input reference frequency	
2	CLKA1 [2]	Buffered clock output, Bank A	
3	CLKA2 ^[2]	Buffered clock output, Bank A	
4	V_{DD}	3.3 V or 2.5 V supply	
5	GND	Ground	
6	CLKB1 [2]	Buffered clock output, Bank B	
7	CLKB2 ^[2]	Buffered clock output, Bank B	
8	S2 ^[3]	Select input, bit 2	
9	S1 ^[3]	Select input, bit 1	
10	CLKB3 ^[2]	Buffered clock output, Bank B	
11	CLKB4 ^[2]	Buffered clock output, Bank B	
12	GND	Ground	
13	V_{DD}	3.3 V or 2.5 V supply	
14	CLKA3 ^[2]	uffered clock output, Bank A	
15	CLKA4 ^[2]	Buffered clock output, Bank A	
16	CLKOUT [2]	Buffered output, internal feedback on this pin	

Notes

- 1. Weak pull-down.
- 2. Weak pull-down on all outputs.
- 3. Weak pull-ups on these inputs.



Select Input Decoding

S2	S1	CLOCK A1-A4	CLOCK B1-B4	CLKOUT [4]	Output Source	PLL Shutdown
0	0	Three-state	Three-state	Driven	PLL	N
0	1	Driven	Three-state	Driven	PLL	N
1	0	Driven	Driven	Driven	Reference	Y
1	1	Driven	Driven	Driven	PLL	N

Zero Delay and Skew Control

All outputs should be uniformly loaded to achieve Zero Delay between the input and output. Since the CLKOUT pin is the internal feedback to the PLL, its relative loading can adjust the input-output delay.

The output driving the CLKOUT pin will be driving a total load of 5 pF (internal load) plus any additional load externally connected to this pin. For applications requiring zero input-output delay, the total load on each output pin (including CLKOUT) must be the

same. For example, if there is no external load on CLKOUT pin, add 5 pF to each of the remaining outputs to match the internal load on CLKOUT pin. If input-output delay adjustments are required, the CLKOUT load may be changed to vary the delay between the REF input and remaining outputs.

For zero output-output skew, be sure to load all outputs equally. For further information refer to the application note titled "AN1234 – Understanding Cypress's Zero Delay Buffers".

Note

Document Number: 38-07760 Rev. *G Page 4 of 19

^{4.} This output is driven and has an internal feedback for the PLL. The load on this output can be adjusted to change the skew between the reference and output.



Absolute Maximum Conditions

Supply voltage to ground potential-0.5 V to 4.6 V DC input voltage V_{SS} – 0.5 V to 4.6 V

Storage temperature	–65 °C to 150 °C
Junction temperature	150 °C
Static discharge voltage	
(per MIL-STD-883, Method 3015)	> 2000 V

Operating Conditions

Parameter	Description	Min	Max	Unit
V _{DD3.3}	3.3 V supply voltage	3.0	3.6	V
V _{DD2.5}	2.5 V supply voltage	2.3	2.7	V
T _A	Operating temperature (ambient temperature) – Commercial	0	70	°C
	Operating temperature (ambient temperature) – Industrial	-40	85	°C
C _L ^[5]	Load capacitance, <100 MHz, 3.3 V	_	30	pF
	Load capacitance, <100 MHz, 2.5 V with High drive	_	30	pF
	Load capacitance, <133.3 MHz, 3.3 V	_	22	pF
	Load capacitance, <133.3 MHz, 2.5 V with High drive	-	22	pF
	Load capacitance, <133.3 MHz, 2.5 V with Standard drive	-	15	pF
	Load capacitance, >133.3 MHz, 3.3 V	_	15	pF
	Load capacitance, >133.3 MHz, 2.5 V with High drive	-	15	pF
C _{IN}	Input capacitance ^[6]	-	5	pF
BW	Closed-loop bandwidth (typical), 3.3 V	1–	1.5	MHz
	Closed-loop bandwidth (typical), 2.5 V	0	.8	MHz
R _{OUT}	Output impedance (typical), 3.3 V High drive	2	9	Ω
	Output impedance (typical), 3.3 V Standard drive	4	1	Ω
	Output impedance (typical), 2.5 V High drive		37	
	Output impedance (typical), 2.5 V Standard drive		1	Ω
t _{PU}	Power-up time for all VDD's to reach minimum specified voltage (power ramps must be monotonic)	0.01	50	ms

Notes

^{5.} Applies to Test Circuit #1.6. Applies to both REF Clock and internal feedback path on CLKOUT.



Electrical Specifications

3.3 V DC

Parameter	Description	Test Conditions	Min	Max	Unit
V_{DD}	Supply voltage		3.0	3.6	V
V _{IL}	Input LOW voltage		_	0.8	V
V _{IH}	Input HIGH voltage		2.0	V _{DD} + 0.3	V
I _{IL}	Input leakage current	0 < V _{IN} < V _{IL}	_	±10	μΑ
I _{IH}	Input HIGH current	$V_{IN} = V_{DD}$	_	100	μΑ
V _{OL}	Output LOW voltage	I _{OL} = 8 mA (standard drive)	_	0.4	V
		I _{OL} = 12 mA (High drive)	_	0.4	V
V _{OH}	Output HIGH voltage	I _{OH} = –8 mA (standard drive)	2.4	_	V
		I _{OH} = –12 mA (High drive)	2.4	_	V
I _{DD} (PD mode)	Power down supply current	REF = 0 MHz (Commercial)	_	12	μΑ
		REF = 0 MHz (Industrial)	_	25	μΑ
I _{DD}	Supply current	Unloaded outputs, 66-MHz REF	_	30	mA

Electrical Specifications

2.5 V DC

Parameter	Description	Test Conditions	Min	Max	Unit
V_{DD}	Supply voltage		2.3	2.7	V
V _{IL}	Input LOW voltage		_	0.7	V
V _{IH}	Input HIGH voltage		1.7	V _{DD} + 0.3	V
I _{IL}	Input leakage current	0 <v<sub>IN < V_{DD}</v<sub>	_	10	μА
I _{IH}	Input HIGH current	$V_{IN} = V_{DD}$	_	100	μА
V _{OL}	Output LOW voltage	I _{OL} = 8 mA (Standard drive)	_	0.5	V
		I _{OL} = 12 mA (High drive)	_	0.5	V
V _{OH}	Output HIGH voltage	I _{OH} = –8 mA (Standard drive)	V _{DD} – 0.6	-	V
		I _{OH} = -12 mA (High drive)	V _{DD} – 0.6	-	V
I _{DD} (PD mode)	Power down supply current	REF = 0 MHz (Commercial)	_	12	μА
		REF = 0 MHz (Industrial)	_	25	μΑ
I _{DD}	Supply current	Unloaded outputs, 66-MHz REF	_	45	mA

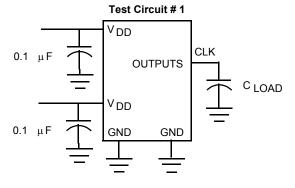


Thermal Resistance

Parameter [7]	Description	Test Conditions	16-pin SOIC	16-pin TSSOP	Unit
θ_{JA}	,	Test conditions follow standard test methods and procedures for measuring		111	°C/W
θ_{JC}	i i nermai registance	thermal impedance, in accordance with EIA/JESD51.	53	26	°C/W

Test Circuits





Note
7. These parameters are guaranteed by design and are not tested.



Electrical Specifications

3.3 V and 2.5 V AC

Parameter	Description	Test Conditions	Min	Тур	Max	Unit
1/t ₁	Maximum frequency [8]	3.3 V High drive	10	_	220	MHz
	(input/output)	3.3 V Standard drive	10	_	167	MHz
		2.5 V High drive	10	-	200	MHz
		2.5 V Standard drive	10	-	133	MHz
T _{IDC}	Input duty cycle	<133.3 MHz	25	-	75	%
		>133.3 MHz	40	_	60	%
t ₂ ÷ t ₁	Output duty cycle [9]	<133.3 MHz	47	_	53	%
		>133.3 MHz	45	_	55	%
t _{3,} t ₄	Rise, fall time (3.3 V) [9]	Std drive, CL = 30 pF, <100 MHz	_	_	1.6	ns
		Std drive, CL = 22 pF, <133.3 MHz	_	_	1.6	ns
		Std drive, CL = 15 pF, <167 MHz	_	_	0.6	ns
		High drive, CL = 30 pF, <100 MHz	_	-	1.2	ns
		High drive, CL = 22 pF, <133.3 MHz	_	_	1.2	ns
		High drive, CL = 15 pF, >133.3 MHz	_	_	0.5	ns
t _{3,} t ₄	Rise, fall time (2.5 V) ^[9]	Std drive, CL = 15 pF, <133.33 MHz	_	_	1.5	ns
,		High drive, CL = 30 pF, <100 MHz	_	_	2.1	ns
		High drive, CL = 22 pF, <133.3 MHz	_	_	1.3	ns
		High drive, CL = 15 pF, >133.3 MHz	_	_	1.2	ns
t ₅	Output to output skew [9]	All outputs equally loaded, 3.3 V supply, 2.5 supply standard drive	-	45	100	ps
		All outputs equally loaded, 2.5 V supply high drive	_	_	110	ps
t ₆	Delay,	PLL Bypass mode	1.5	-	4.4	ns
	REF rising edge to CLKOUT rising edge [9]	PLL enabled @ 3.3 V	-100	-	100	ps
	inemig sugs	PLL enabled @2.5 V	-200	-	200	ps
t ₇	Part to part skew ^[9]	Measured at V _{DD} /2. Any output to any output, 3.3 V supply	-	_	±150	ps
		Measured at V _{DD} /2. Any output to any output, 2.5 V supply	-	_	±300	ps
t _{LOCK}	PLL lock time ^[9]	Stable power supply, valid clocks presented on REF and CLKOUT pins	-	_	1.0	ms

<sup>Notes
8. For the given maximum loading conditions. See C_L in Operating Conditions Table.
9. Parameter is guaranteed by design and characterization. Not 100% tested in production.</sup>



Electrical Specifications (continued)

3.3 V and 2.5 V AC

Parameter	Description	Test Conditions	Min	Тур	Max	Unit
T _{JCC} ^[10, 11]	Cycle-to-cycle jitter, peak	3.3 V supply, >66 MHz, <15 pF	_	25	55	ps
		3.3 V supply, >66 MHz, <30 pF, standard drive	-	65	125	ps
		3.3 V supply, >66 MHz, <30 pF, high drive	-	53	100	ps
		2.5 V supply, >66 MHz, <15 pF, standard drive	-	35	95	ps
		2.5 V supply, >66 MHz, <15 pF, high drive	-	30	65	ps
		2.5 V supply, >66 MHz, <30 pF, high drive	-	75	145	ps
		S2:S1 = 1:0 mode, 3.3 V, <15 pF, standard drive	-	16	_	ps
		S2:S1 = 1:0 mode, 3.3 V, <15 pF, high drive	-	14	_	ps
		S2:S1 = 1:0 mode, 2.5 V, <15 pF, standard drive	-	23	_	ps
		S2:S1 = 1:0 mode, 2.5 V, <15 pF, high drive	-	22	_	ps
T _{PER} ^[10, 11]	Period jitter, peak	3.3 V supply, 66–100 MHz, <15 pF	_	20	75	ps
		3.3 V supply, >100 MHz, <15 pF	-	15	45	ps
		3.3 V supply, >66 MHz, <30 pF, standard drive	-	40	100	ps
		3.3 V supply, >66 MHz, <30 pF, high drive	-	30	70	ps
		2.5 V supply, >66 MHz, <15 pF, standard drive	_	25	60	ps
		2.5 V supply, 66–100 MHz, <15 pF, high drive	-	25	60	ps
		2.5 V supply, >100 MHz, <15 pF, high drive	-	15	45	ps
		S2:S1 = 1:0 mode, 3.3 V, <15 pF, standard drive	-	28	_	ps
		S2:S1 = 1:0 mode, 3.3 V, <15 pF, high drive	_	24	_	ps
		S2:S1 = 1:0 mode, 2.5 V, <15 pF, standard drive	_	40	_	ps
		S2:S1 = 1:0 mode, 2.5 V, <15 pF, high drive	-	37	_	ps

Parameter is guaranteed by design and characterization. Not 100% tested in production.
 Parameter is guaranteed by design and characterization. Not 100% tested in production.
 Typical jitter is measured at 3.3 V or 2.5 V, 29 °C, with all outputs driven into the maximum specified load. Further information regarding jitter specifications may be found in the application note "Understanding Data Sheet Jitter Specifications for Cypress Clock Products."



Switching Waveforms

Figure 3. Duty Cycle Timing

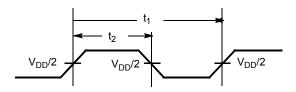


Figure 4. All Outputs Rise/Fall Time

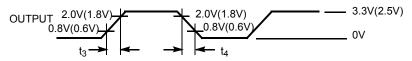


Figure 5. Output-Output Skew

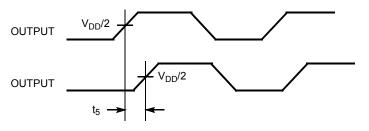


Figure 6. Input-Output Propagation Delay

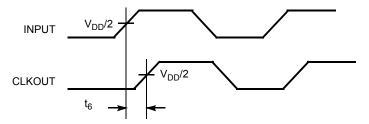
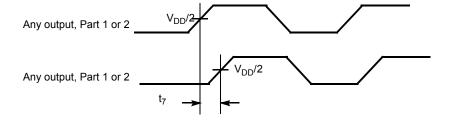


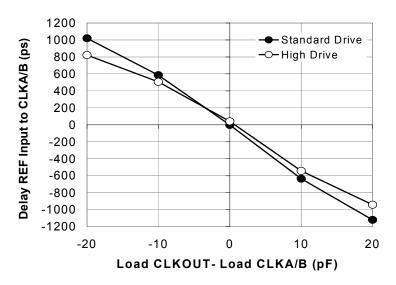
Figure 7. Part-Part Skew





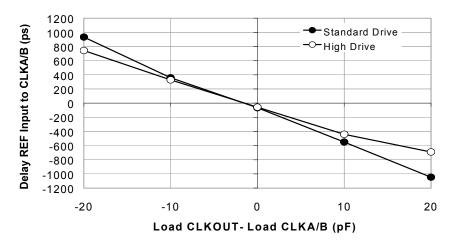
Supplemental Parametric Information

Figure 8. 2.5 V Typical Room Temperature Graph for REF Input to CLKA/CLKB Delay Versus Loading Difference between CLKOUT and CLKA/CLKB



Data is shown for 66 MHz. Delay is a weak function of frequency.

Figure 9. 3.3 V Typical Room Temperature Graph for REF Input to CLKA/CLKB Delay Versus Loading Difference between CLKOUT and CLKA/CLKB

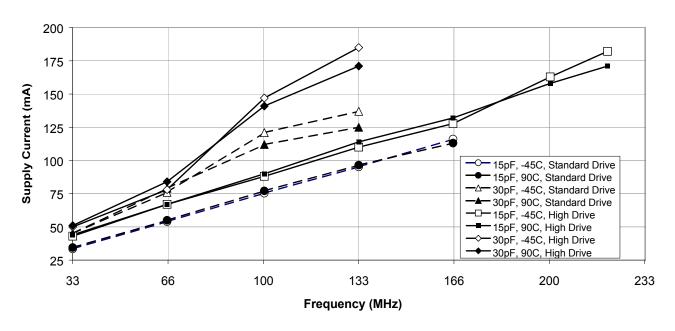


Data is shown for 66 MHz. Delay is a weak function of frequency.



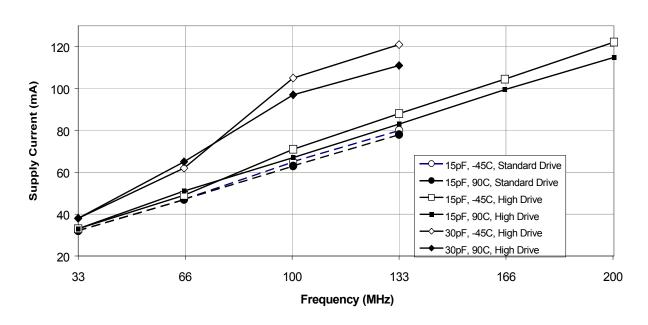
Supplemental Parametric Information (continued)

Figure 10. 3.6 V Measured Supply Current versus Frequency, Drive Strength, Loading, and Temperature



Note that the 30-pF data above 100 MHz is beyond the data sheet specification of 22 pF.

Figure 11. 2.7 V Measured Supply Current Versus Frequency, Drive Strength, Loading, and Temperature



Note that the 30-pF high-drive data above 100bMHz is beyond the data sheet specification of 22 pF.



Supplemental Parametric Information (continued)

Figure 12. Typical 3.3 V Measured Cycle-to-cycle Jitter at 29 °C, versus Frequency, Drive Strength, and Loading

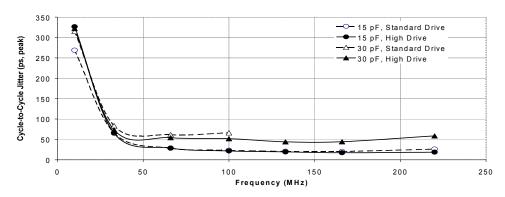


Figure 13. Typical 2.5 V Measured Cycle-to-cycle Jitter at 29 °C, versus Frequency, Drive Strength, and Loading

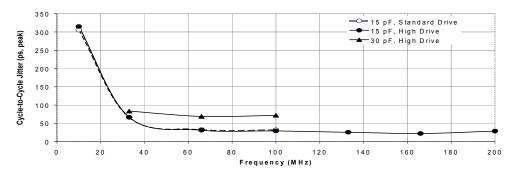


Figure 14. Typical 3.3 V Measured Period Jitter at 29 °C, versus Frequency, Drive Strength, and Loading

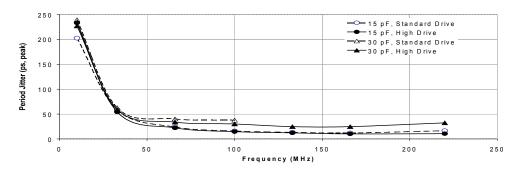
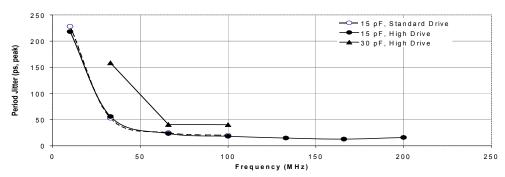


Figure 15. Typical 2.5 V Measured Period Jitter at 29 °C, versus Frequency, Drive Strength, and Loading

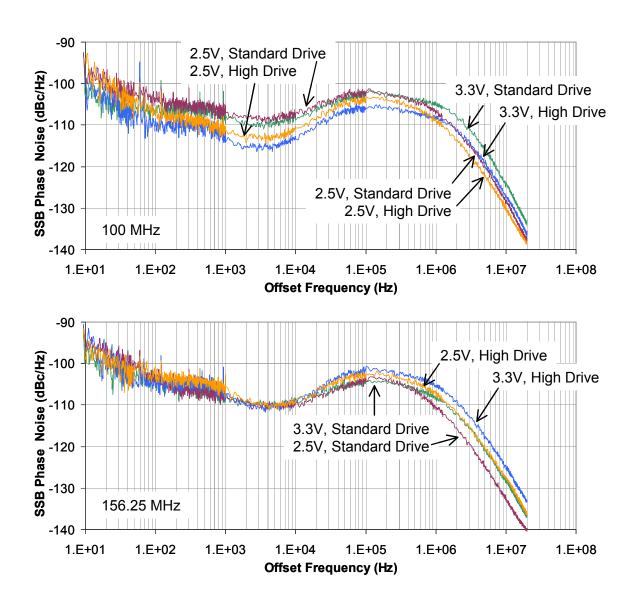


Document Number: 38-07760 Rev. *G Page 13 of 19



Supplemental Parametric Information (continued)

Figure 16. Typical Phase-noise Data at 100 MHz (top) and 156.25 MHz (bottom) across V_{DD} and Drive Strength ^[12]



Note

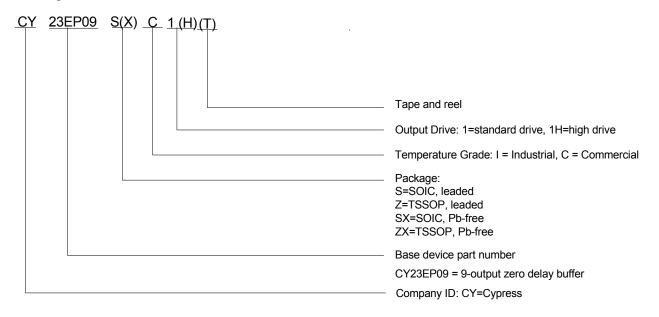
^{12.} Typical jitter is measured at 3.3 V or 2.5 V, 29 °C, with all outputs driven into the maximum specified load. Further information regarding jitter specifications may be found in the application note "Understanding Data Sheet Jitter Specifications for Cypress Clock Products."



Ordering Information

Ordering Code	Package Type	Operating Range
Pb-free		
CY23EP09SXC-1	16-pin SOIC	Commercial
CY23EP09SXC-1T	16-pin SOIC – Tape and Reel	Commercial
CY23EP09SXI-1	16-pin SOIC	Industrial
CY23EP09SXI-1T	16-pin SOIC – Tape and Reel	Industrial
CY23EP09SXC-1H	16-pin SOIC	Commercial
CY23EP09SXC-1HT	16-pin SOIC – Tape and Reel	Commercial
CY23EP09SXI-1H	16-pin SOIC	Industrial
CY23EP09SXI-1HT	16-pin SOIC – Tape and Reel	Industrial
CY23EP09ZXC-1H	16-pin TSSOP	Commercial
CY23EP09ZXC-1HT	16-pin TSSOP – Tape and Reel	Commercial
CY23EP09ZXI-1H	16-pin TSSOP	Industrial
CY23EP09ZXI-1HT	16-pin TSSOP – Tape and Reel	Industrial

Ordering Code Definitions

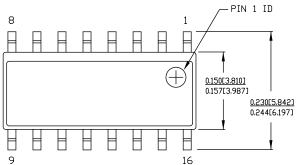


Document Number: 38-07760 Rev. *G Page 15 of 19



Package Diagrams

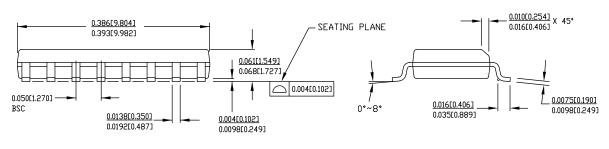
Figure 17. 16-pin SOIC (150 Mils) S16.15/SZ16.15 Package Outline, 51-85068



NOTE:

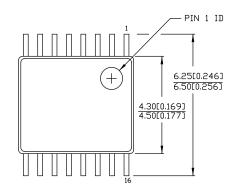
- 1. DIMENSIONS IN INCHES[MM] MANK.
- 2. REFERENCE JEDEC MS-012
- 3. PACKAGE WEIGHT: refer to PMDD spec. 001-04308

PART #				
\$16.15	STANDARD PKG.			
SZ16.15	LEAD FREE PKG.			



51-85068 *E

Figure 18. 16-pin TSSOP (4.40 mm Body) Z16.173/ZZ16.173 Package Outline, 51-85091

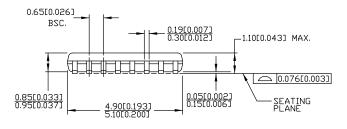


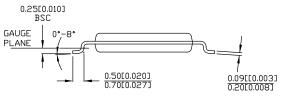
DIMENSIONS IN MMEINCHES) MIN. MAX.

REFERENCE JEDEC MO-153

PACKAGE WEIGHT 0.05gms

PART #					
Z16.173	STANDARD PKG.				
ZZ16.173	LEAD FREE PKG.				





51-85091 *E



Acronyms

Acronym	Description		
PCI	Personal Computer Interconnect		
PLL	Phase Locked Loop		
SDRAM	DRAM Synchronous Dynamic Random Access Memo		
SOIC	Small Outline Integrated Circuit		
TSSOP	Thin-Shrink Small Outline Package		
ZDB	Zero Delay Buffer		

Document Conventions

Units of Measure

Symbol	Units of Measure	
°C	degree Celsius	
MHz	megahertz	
μΑ	microampere	
mA	milliampere	
ms	millisecond	
ns	nanosecond	
pF	picofarad	
ps	picosecond	
V	volt	



Document History Page

Rev.	ECN No.	Issue Date	Orig. of Change	Description of Change
**	345446	See ECN	RGL	New data sheet.
*A	355777	See ECN	RGL	Updated Electrical Specifications: Updated values of t ₇ parameter (to agree with latest char results).
*B	401036	See ECN	RGL	Changed status from Preliminary to Final. Updated Electrical Specifications: Updated details in "Test Conditions" column corresponding to T _{JCC} and T _{PER} parameters. Updated Supplemental Parametric Information: Added Figure 8. Added Figure 16.
*C	3270178	06/01/2011	BASH	Updated Package Diagrams. Added Acronyms and Units of Measure. Updated to new template.
*D	4400992	06/10/2014	AJU	Updated Operating Conditions: Updated values of Theta Ja and Theta Jc parameters (corresponding to 16-pin TSSOP package). Updated Package Diagrams: spec 51-85068 – Changed revision from *C to *E. spec 51-85091 – Changed revision from *C to *D. Updated to new template. Completing Sunset Review.
*E	4580603	11/26/2014	AJU	Updated Functional Description: Added "For a complete list of related documentation, click here." at the end. Updated Package Diagrams.
*F	5243008	04/26/2016	PSR	Updated Zero Delay and Skew Control: Updated description. Updated Operating Conditions: Removed "Theta Ja", "Theta Jc" parameters and their details. Removed Note "Theta Ja, EIA JEDEC 51 test board conditions, 2S2P; Theta Jc Mil-Spec 883E Method 1012.1." and its reference. Added Thermal Resistance. Updated to new template. Completing Sunset Review.
*G	5993917	12/14/2017	AESATMP8	Updated logo and Copyright.



Sales, Solutions, and Legal Information

Worldwide Sales and Design Support

Cypress maintains a worldwide network of offices, solution centers, manufacturer's representatives, and distributors. To find the office closest to you, visit us at Cypress Locations.

Products

ARM® Cortex® Microcontrollers

Automotive

Clocks & Buffers

Interface

Internet of Things

cypress.com/automotive

cypress.com/clocks

cypress.com/interface

cypress.com/interface

cypress.com/iot

Memory cypress.com/memory
Microcontrollers cypress.com/mcu
PSoC cypress.com/psoc

Power Management ICs cypress.com/pmic
Touch Sensing cypress.com/touch
USB Controllers cypress.com/usb
Wireless Connectivity cypress.com/wireless

PSoC®Solutions

PSoC 1 | PSoC 3 | PSoC 4 | PSoC 5LP | PSoC 6

Cypress Developer Community

Forums | WICED IOT Forums | Projects | Video | Blogs | Training | Components

Technical Support

cypress.com/support

© Cypress Semiconductor Corporation, 2010-2017. This document is the property of Cypress Semiconductor Corporation and its subsidiaries, including Spansion LLC ("Cypress"). This document, including any software or firmware included or referenced in this document ("Software"), is owned by Cypress under the intellectual property laws and treaties of the United States and other countries worldwide. Cypress reserves all rights under such laws and treaties and does not, except as specifically stated in this paragraph, grant any license under its patents, copyrights, trademarks, or other intellectual property rights. If the Software is not accompanied by a license agreement and you do not otherwise have a written agreement with Cypress governing the use of the Software, then Cypress hereby grants you a personal, non-exclusive, nontransferable license (without the right to sublicenses) (1) under its copyright rights in the Software (a) for Software provided in source code form, to modify and reproduce the Software solely for use with Cypress hardware products, only internally within your organization, and (b) to distribute the Software in binary code form externally to end users (either directly or indirectly through resellers and distributors), solely for use on Cypress hardware product units, and (2) under those claims of Cypress's patents that are infringed by the Software (as provided by Cypress, unmodified) to make, use, distribute, and import the Software solely for use with Cypress hardware products. Any other use, reproduction, modification, translation, or compilation of the Software is prohibited.

TO THE EXTENT PERMITTED BY APPLICABLE LAW, CYPRESS MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARD TO THIS DOCUMENT OR ANY SOFTWARE OR ACCOMPANYING HARDWARE, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE. To the extent permitted by applicable law, Cypress reserves the right to make changes to this document without further notice. Cypress does not assume any liability arising out of the application or use of any product or circuit described in this document. Any information provided in this document, including any sample design information or programming code, is provided only for reference purposes. It is the responsibility of the user of this document to properly design, program, and test the functionality and safety of any application made of this information and any resulting product. Cypress products are not designed, intended, or authorized for use as critical components in systems designed or intended for the operation of weapons, weapons systems, nuclear installations, life-support devices or systems, other medical devices or systems (including resuscitation equipment and surgical implants), pollution control or hazardous substances management, or other uses where the failure of the device or system could cause personal injury, death, or property damage ("Unintended Uses"). A critical component is any component of a device or system whose failure to perform can be reasonably expected to cause the failure of the device or system, or to affect its safety or effectiveness. Cypress is not liable, in whole or in part, and you shall and hereby do release Cypress from any claim, damage, or other liability arising from or related to all Unintended Uses of Cypress products. You shall indemnify and hold Cypress harmless from and against all claims, costs, damages, and other liabilities, including claims for personal injury or death, arising from or related to any Unintended Uses of Cypress products.

Cypress, the Cypress logo, Spansion, the Spansion logo, and combinations thereof, WICED, PSoC, CapSense, EZ-USB, F-RAM, and Traveo are trademarks or registered trademarks of Cypress in the United States and other countries. For a more complete list of Cypress trademarks, visit cypress.com. Other names and brands may be claimed as property of their respective owners.

Document Number: 38-07760 Rev. *G Revised December 14, 2017 Page 19 of 19

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Cypress Semiconductor:

<u>CY23EP09SXC-11 CY23EP09SXC-1H CY23EP09SXC-1H CY23EP09SXC-1T CY23EP09SXI-1 CY23EP09SXI-1H CY23EP09SXI-1H CY23EP09SXI-1H CY23EP09ZXC-1H CY23EP09ZXI-1H CY23EP</u>